

Memory With 6T Small Aspect Ratio Cells Having Metal<sub>1</sub> Elements  
Physically Connected to Metal<sub>0</sub> Elements

ABSTRACT OF THE DISCLOSURE

A method of forming memory circuit (20) comprising a plurality of six transistor memory cells (SC<sub>2</sub>(WL,C)). The method forms each of the six transistor memory cells to comprise a first inverter having an input and an output and a second inverter having an input and an output. The inverters comprise respective first and second drive transistors (DT1, DT2), each comprising first and second source/drain regions and a gate, and first and second pull-up transistors (PT1, PT2), each comprising first and second source/drain regions and a gate. The output of the first inverter is coupled to the first source/drain region of the first drive transistor and to the first source/drain region of the first pull up transistor. The output of the second inverter is coupled to the first source/drain region of the second drive transistor and to the first source/drain region of the second pull up transistor. Each cell further comprises a first and second access transistor (AT1, AT2), each having a gate, and having a first source/drain region coupled to an inverter output and a second source/drain region for communicating to a corresponding bit line. The method also forms at least one insulating layer (128) in a position relative to the first through sixth transistors, and applies a first mask to the at least one insulating layer to form a plurality of vias through the at least one insulating layer. The method also forms a first conducting layer comprising a plurality of conducting plugs (130<sub>x</sub>) in the plurality of vias. The plurality of conducting plugs comprise a first conducting plug (130<sub>4</sub>) coupled to the output of the first inverter and a second conducting plug (130<sub>11</sub>) coupled to the first source/drain region of the first pull-up transistor and to the gate of the second drive transistor and to the gate of the second pull-up transistor. The plurality of conducting plugs further comprise a third conducting plug (130<sub>5</sub>) coupled to the output of the second inverter and a fourth conducting plug (130<sub>12</sub>) coupled to the first source/drain region of the second pull-up transistor and to the gate of the first drive transistor and to the gate of the first pull-up transistor. The method also forms a second conducting layer comprising a plurality of conducting elements (132<sub>x</sub>). The plurality of conducting elements comprise a first

conducting element (132<sub>9</sub>) coupled to and physically contacting the first conducting plug  
and coupled to and physically contacting the second conducting plug and a second  
30 conducting element (132<sub>10</sub>) coupled to and physically contacting the third conducting plug  
and coupled to and physically contacting the fourth conducting plug.

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